

## 18NM70

Power MOSFET

18A, 700V N-CHANNEL  
SUPER-JUNCTION MOSFET

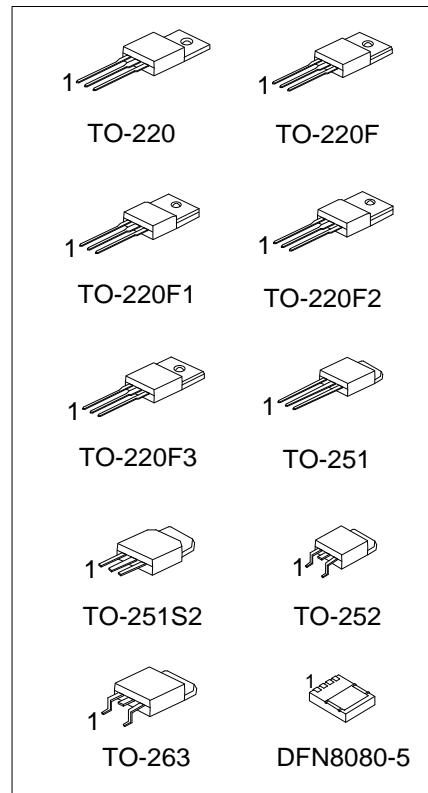
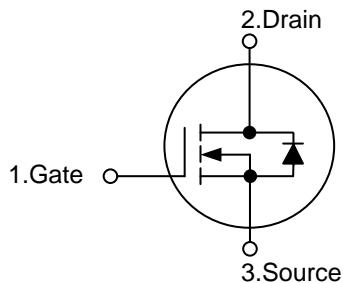
## ■ DESCRIPTION

The **UTC 18NM70** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

## ■ FEATURES

- \*  $R_{DS(ON)} \leq 0.35\Omega$  @  $V_{GS}=10V$ ,  $I_D=9.0A$
- \* Fast Switching Capability
- \* Avalanche Energy Specified
- \* Improved dv/dt Capability, High Ruggedness

## ■ SYMBOL

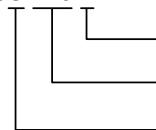


## ■ ORDERING INFORMATION

Ordering Number	Lead Free	Halogen Free	Package	Pin Assignment								Packing
				1	2	3	4	5	6	7	8	
18NM70L-TA3-T	18NM70G-TA3-T	TO-220	G D S - - - -									Tube
18NM70L-TF3-T	18NM70G-TF3-T	TO-220F	G D S - - - -									Tube
18NM70L-TF1-T	18NM70G-TF1-T	TO-220F1	G D S - - - -									Tube
18NM70L-TF2-T	18NM70G-TF2-T	TO-220F2	G D S - - - -									Tube
18NM70L-TF3T-T	18NM70G-TF3T-T	TO-220F3	G D S - - - -									Tube
18NM70L-TM3-T	18NM70G-TM3-T	TO-251	G D S - - - -									Tube
18NM70L-TMS2-T	18NM70G-TMS2-T	TO-251S2	G D S - - - -									Tube
18NM70L-TN3-R	18NM70G-TN3-R	TO-252	G D S - - - -									Tape Reel
18NM70L-TQ2-T	18NM70G-TQ2-T	TO-263	G D S - - - -									Tube
18NM70L-TQ2-R	18NM70G-TQ2-R	TO-263	G D S - - - -									Tape Reel
18NM70L-K05-8080-R	18NM70G-K05-8080-R	DFN8080-5	G S1 S2 S2 D D D D									Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

18NM70G-TA3-T



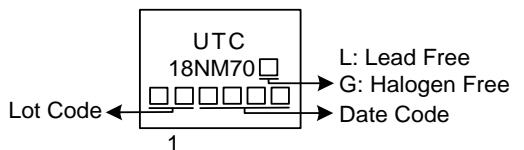
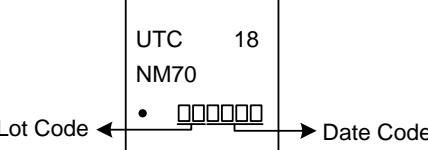
(1)Packing Type

(2)Package Type

(3)Green Package

(1) T: Tube, R: Tape Reel  
 (2) TA3: TO-220, TF3: TO-220F, TF1: TO-220F1,  
 TF2: TO-220F2, TF3T: TO-220F3, TM3: TO-251,  
 TMS2: TO-251S2, TN3: TO-252, TQ2: TO-263  
 K05-8080: DFN8080-5  
 (3) G: Halogen Free and Lead Free, L: Lead Free

**■ MARKING**

TO-220 / TO-220F / TO-220F1 / TO-220F2 TO-220F3 / TO-251 / TO-251S2 / TO-252 / TO-263	DFN8080-5
 Lot Code ← 1 → Date Code	 Lot Code ← • → Date Code

■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain to Source Voltage		$V_{DSS}$	700	V
Gate to Source Voltage		$V_{GSS}$	$\pm 30$	V
Continuous Drain Current	Continuous	$I_D$	18	A
Pulsed Drain Current	Pulsed (Note 2)	$I_{DM}$	45	A
Avalanche Current		$I_{AR}$	4.1	A
Avalanche Energy	Single Pulsed (Note 3)	$E_{AS}$	204.8	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns
Power Dissipation	TO-220/TO-263	$P_D$	104	W
	TO-220F/TO-220F1		33	W
	TO-220F2/ TO-220F3			
	TO-251/TO-251S		83	W
	TO-251S2/TO-252		60	W
DFN8080-5				
Junction Temperature		$T_J$	+150	$^\circ\text{C}$
Storage Temperature		$T_{STG}$	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3.  $L=10\text{mH}$ ,  $I_{AS}=6.3\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .

4.  $I_{SD} \leq 18\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$ .

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	TO-220/TO-220F	$\theta_{JA}$	62.5	$^\circ\text{C/W}$
	TO-220F1/TO-220F2			
	TO-220F3/TO-263			
	TO-251/TO-251S			
	TO-251S2			
Junction to Case	TO-252	$\theta_{JC}$	110	$^\circ\text{C/W}$
	DFN8080-5			
	TO-220/TO-263			
	TO-220F/TO-220F1			
	TO-220F2/TO-220F3			
	TO-251/TO-251S		1.5 (Note)	$^\circ\text{C/W}$
	TO-251S2/TO-252			
	DFN8080-5			

Note: The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

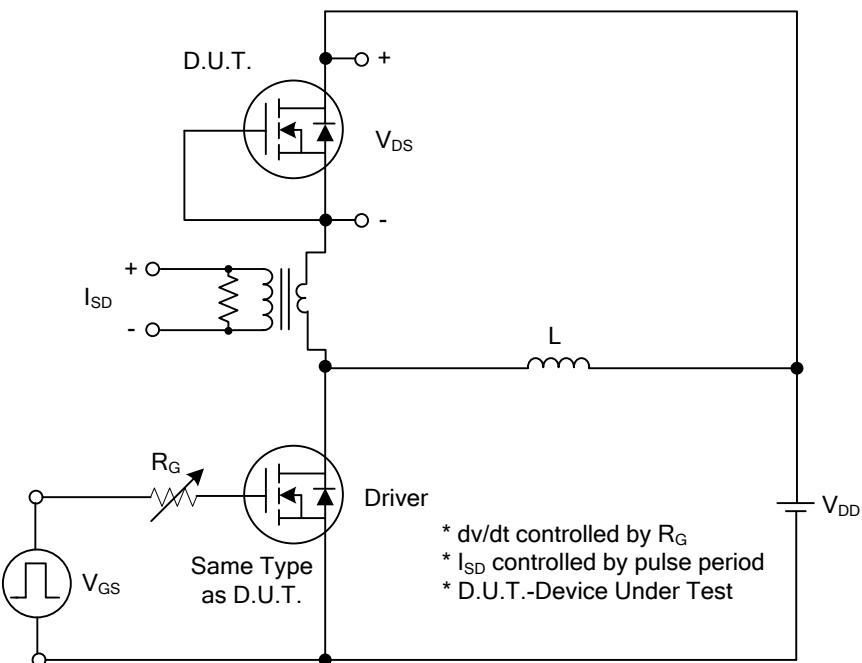
■ ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	700			V
Drain-Source Leakage Current	$I_{\text{DSS}}$	$V_{\text{DS}}=700\text{V}, V_{\text{GS}}=0\text{V}$			10	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{DS}}=0\text{V}, V_{\text{GS}}=\pm 30\text{V}$			$\pm 100$	nA
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	$V_{\text{GS}(\text{TH})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2.5		4.5	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=9.0\text{A}$			0.35	$\Omega$
<b>DYNAMIC PARAMETERS</b>						
Input Capacitance	$C_{\text{ISS}}$	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=25\text{V}, f=1\text{MHz}$		1127		pF
Output Capacitance	$C_{\text{OSS}}$			794		pF
Reverse Transfer Capacitance	$C_{\text{RSS}}$			71		pF
<b>SWITCHING PARAMETERS</b>						
Total Gate Charge (Note 1)	$Q_G$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A}, I_{\text{G}}=1\text{mA}$ (Note 1, 2)		52		nC
Gate to Source Charge	$Q_{\text{GS}}$			10.4		nC
Gate to Drain Charge	$Q_{\text{GD}}$			12.4		nC
Turn-ON Delay Time (Note 1)	$t_{\text{D(ON)}}$	$V_{\text{DS}}=100\text{V}, V_{\text{GS}}=10\text{V}, I_{\text{D}}=18\text{A}, R_{\text{G}}=25\Omega$ (Note 1, 2)		24		ns
Rise Time	$t_R$			61		ns
Turn-OFF Delay Time	$t_{\text{D(OFF)}}$			154		ns
Fall-Time	$t_F$			51		ns
<b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b>						
Maximum Body-Diode Continuous Current	$I_S$				18	A
Maximum Body-Diode Pulsed Current	$I_{\text{SM}}$				54	A
Drain-Source Diode Forward Voltage (Note 1)	$V_{\text{SD}}$	$I_S=18\text{A}, V_{\text{GS}}=0\text{V}$			1.5	V
Body Diode Reverse Recovery Time (Note 1)	$t_{\text{rr}}$	$I_S=18\text{A}, V_{\text{GS}}=0\text{V}$		468		ns
Body Diode Reverse Recovery Charge	$Q_{\text{rr}}$	$dI_F/dt=100\text{A}/\mu\text{s}$		7.8		$\mu\text{C}$

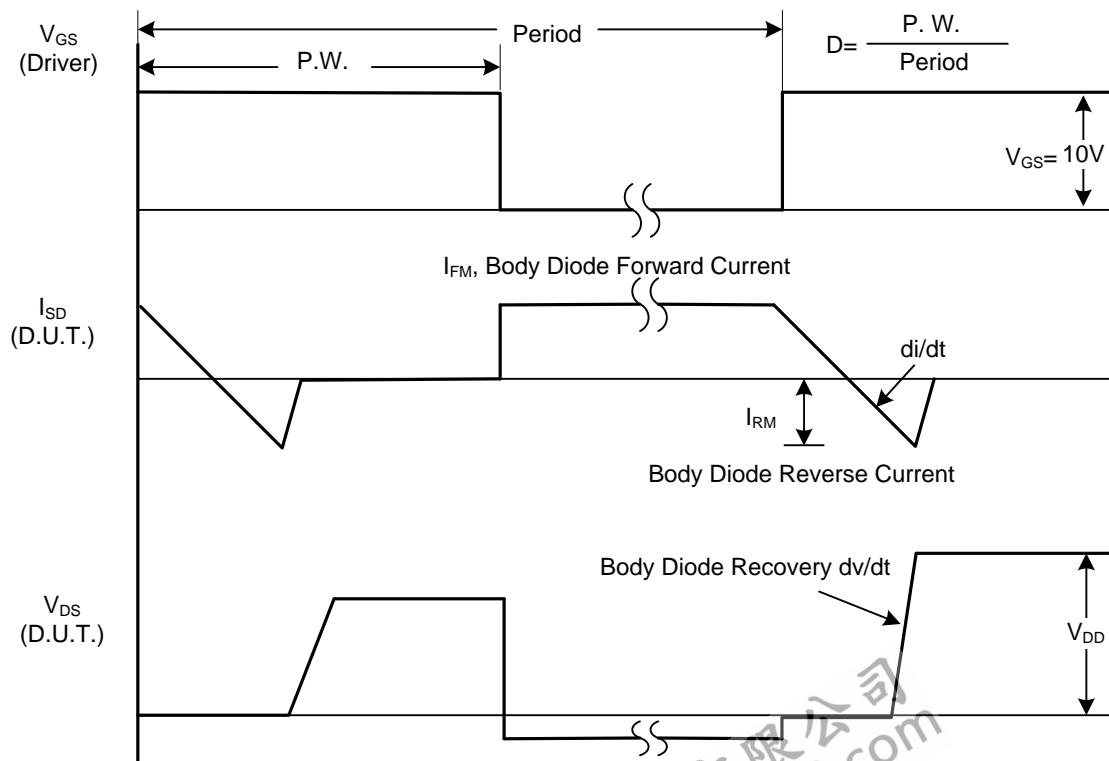
Notes: 1. Pulse Test : Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating ambient temperature.

## ■ TEST CIRCUITS AND WAVEFORMS

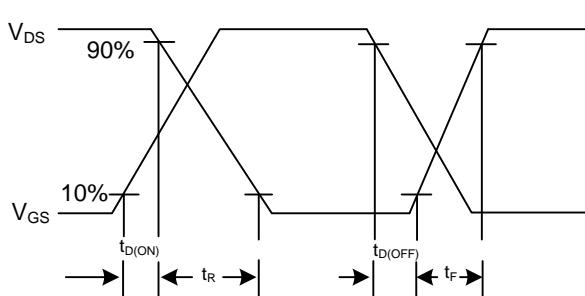
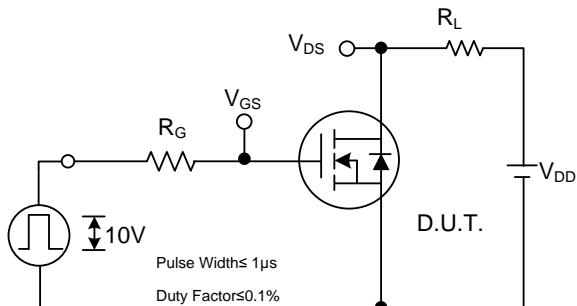


Peak Diode Recovery dv/dt Test Circuit



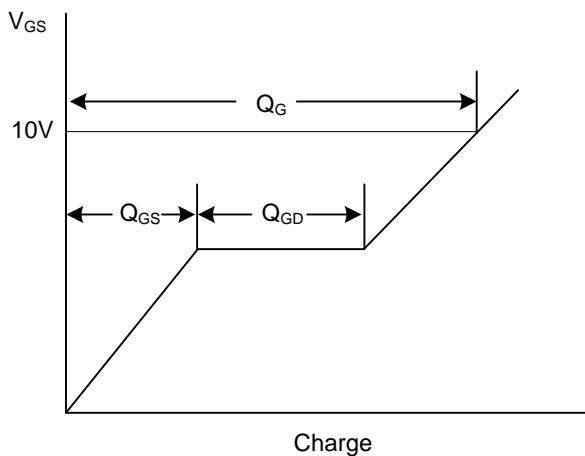
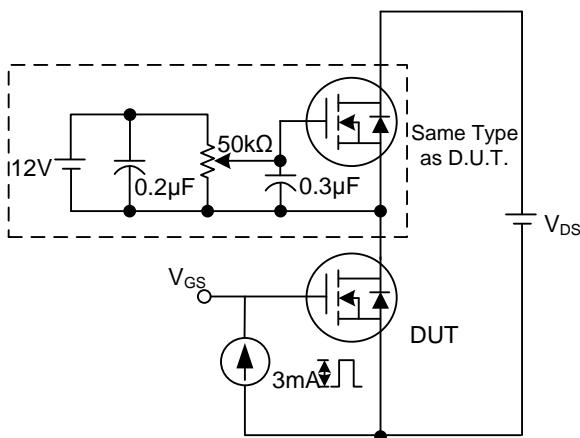
Peak Diode Recovery dv/dt Waveforms

## ■ TEST CIRCUITS AND WAVEFORMS



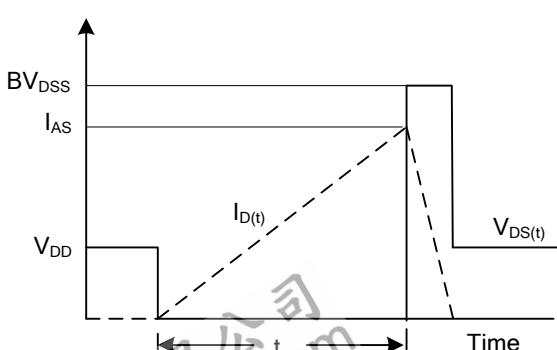
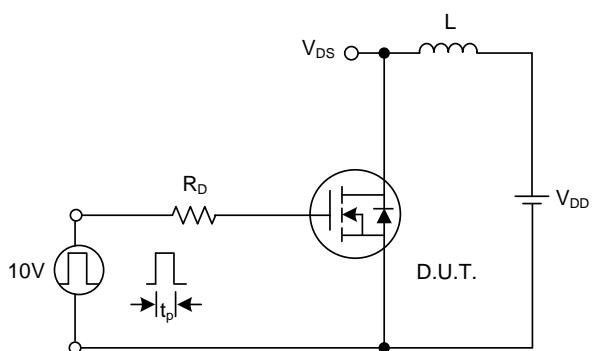
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

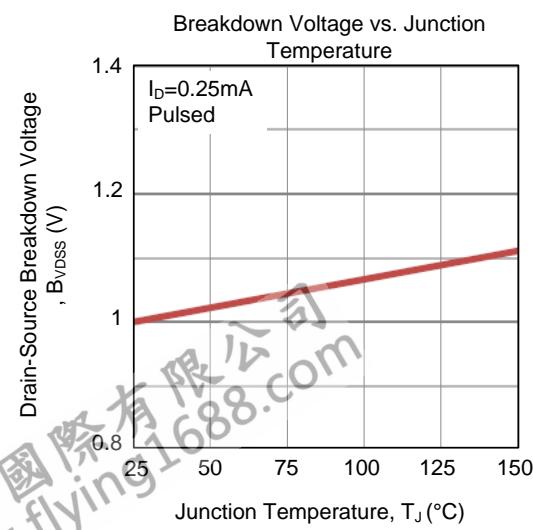
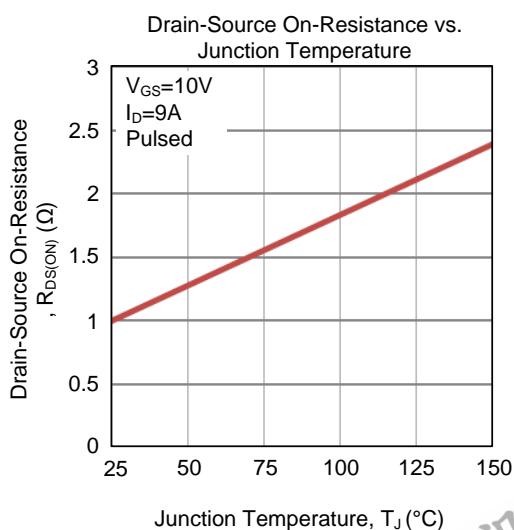
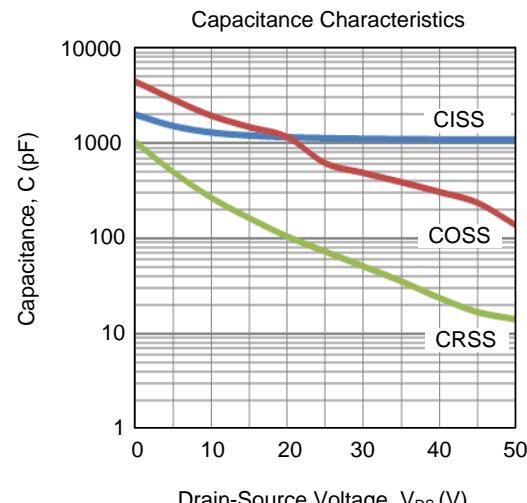
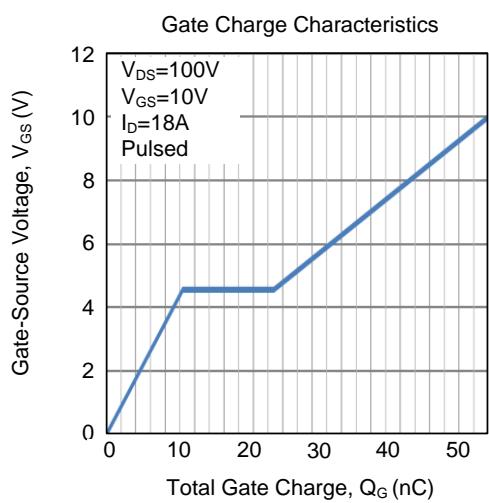
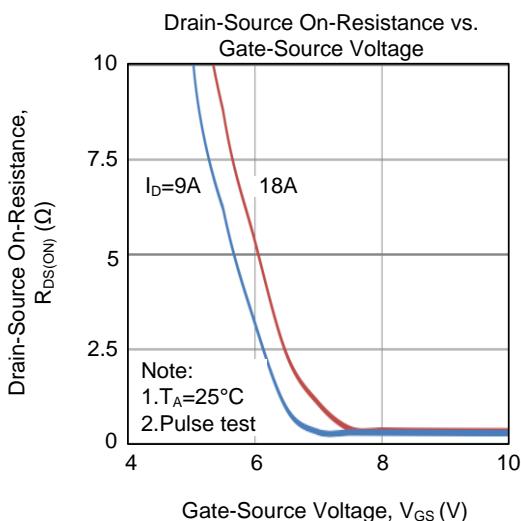
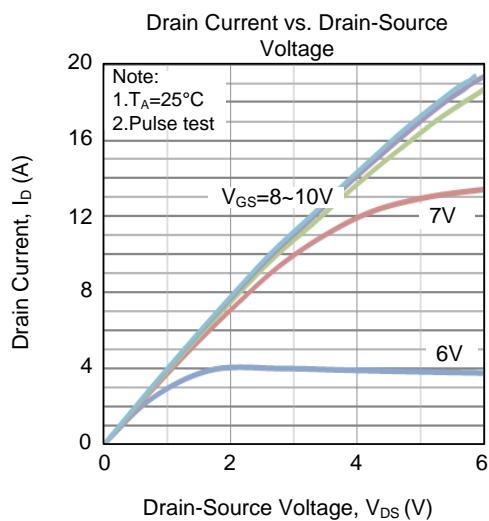
Gate Charge Waveform



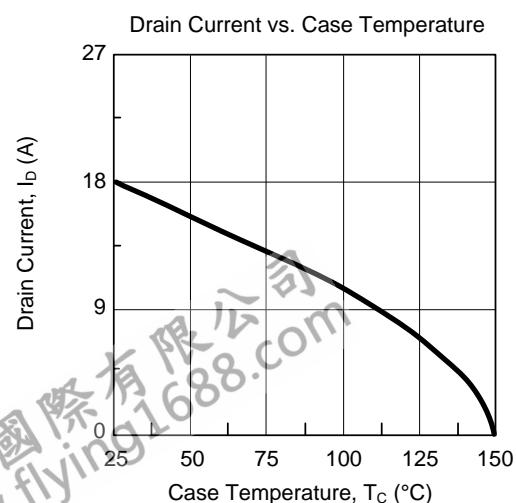
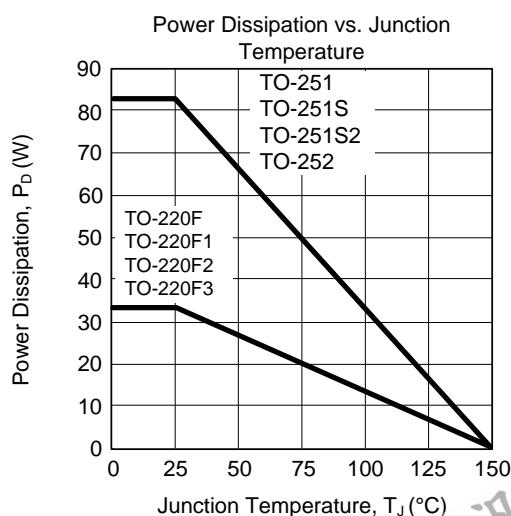
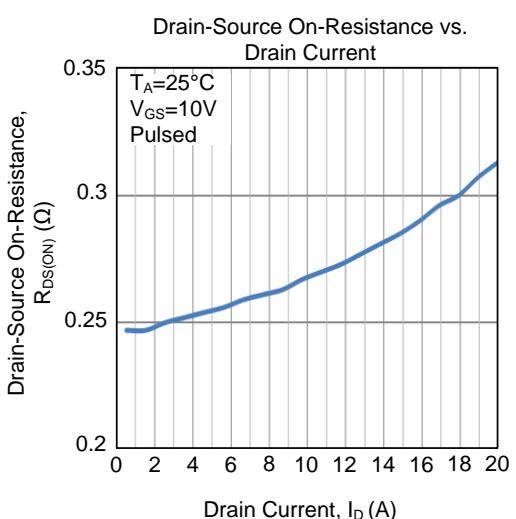
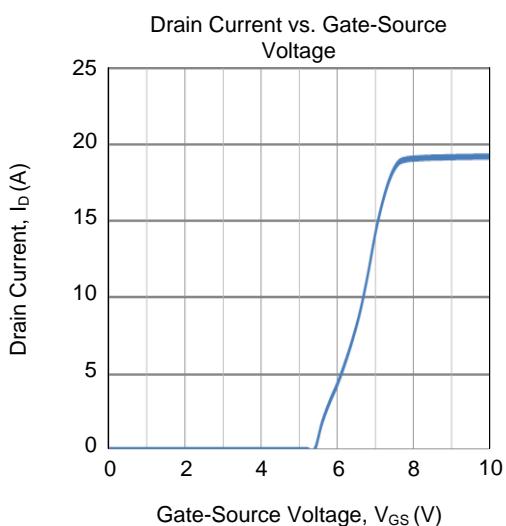
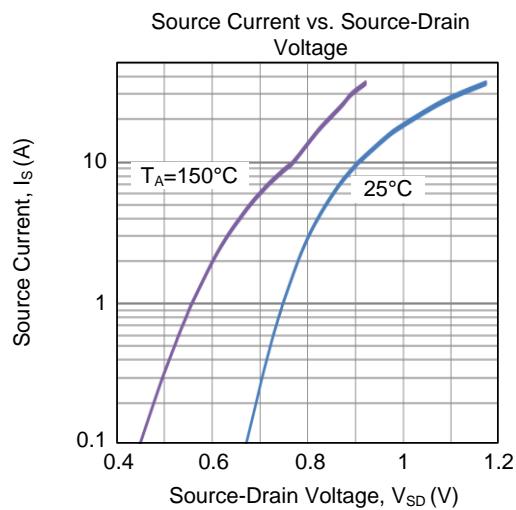
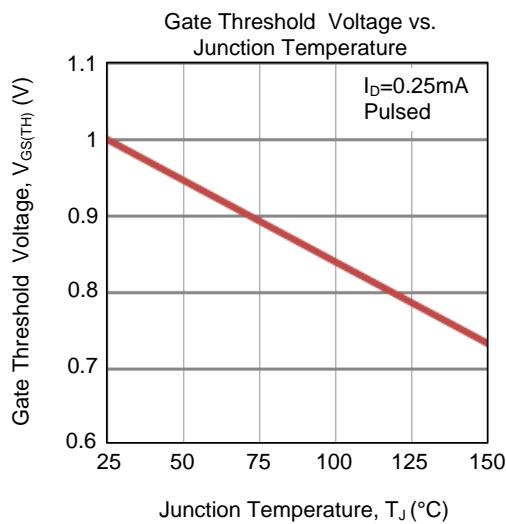
Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

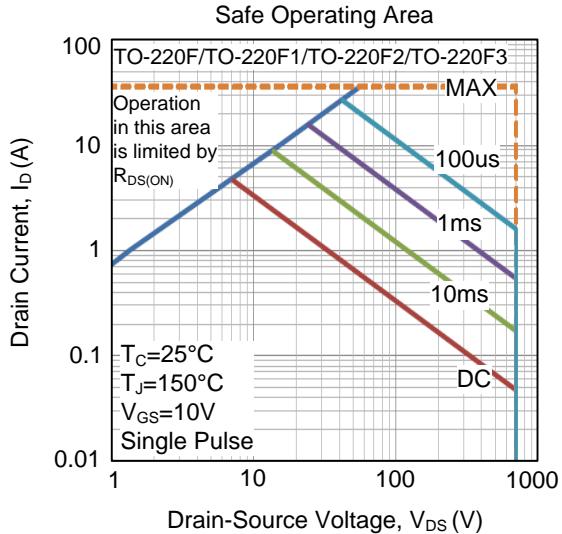
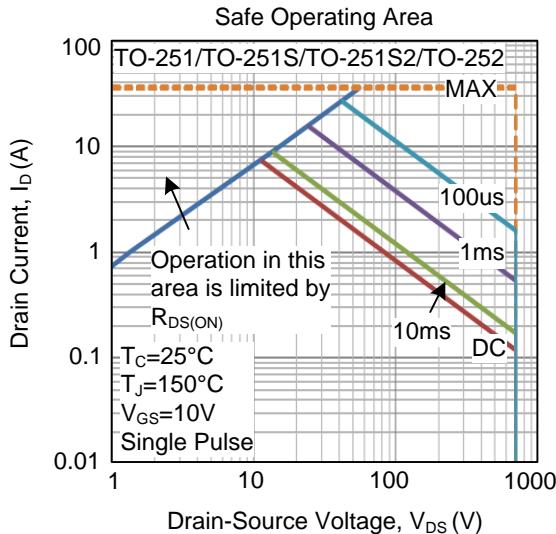
## ■ TYPICAL CHARACTERISTICS



## ■ TYPICAL CHARACTERISTICS (Cont.)



### ■ TYPICAL CHARACTERISTICS (Cont.)



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